

IR2181(4)(S) & (PbF)

HIGH AND LOW SIDE DRIVER

Features

- Floating channel designed for bootstrap operation
Fully operational to +600V
Tolerant to negative transient voltage
dV/dt immune
- Gate drive supply range from 10 to 20V
- Undervoltage lockout for both channels
- 3.3V and 5V input logic compatible
- Matched propagation delay for both channels
- Logic and power ground +/- 5V offset.
- Lower di/dt gate driver for better noise immunity
- Output source/sink current capability 1.4A/1.8A
- Also available LEAD-FREE (PbF)

Packages



IR2181/IR2183/IR2184 Feature Comparison

| Part | Input logic | Cross-conduction prevention logic | Dead-Time | Ground Pins | Ton/Toff |
|-------|---------------------|-----------------------------------|--------------------|-------------|------------|
| 2181 | HIN/LIN | no | none | COM | 180/220 ns |
| 21814 | | | | VSS/COM | |
| 2183 | HIN/LIN | yes | Internal 500ns | COM | 180/220 ns |
| 21834 | | | Program 0.4 ~ 5 us | VSS/COM | |
| 2184 | IN/ \overline{SD} | yes | Internal 500ns | COM | 680/270 ns |
| 21844 | | | Program 0.4 ~ 5 us | VSS/COM | |

Description

The IR2181(4)(S) are high voltage, high speed power MOSFET and IGBT drivers with independent high and low side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The logic input is compatible with standard CMOS or LSTTL output, down to 3.3V logic. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. The floating channel can be used to drive an N-channel power MOSFET or IGBT in the high side configuration which operates up to 600 volts.

Typical Connection



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Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

| Symbol | Definition | Min. | Max. | Units | |
|---------------------|--|-----------------------|-----------------------|-------|------|
| V _B | High side floating absolute voltage | -0.3 | 625 | V | |
| V _S | High side floating supply offset voltage | V _B - 25 | V _B + 0.3 | | |
| V _{HO} | High side floating output voltage | V _S - 0.3 | V _B + 0.3 | | |
| V _{CC} | Low side and logic fixed supply voltage | -0.3 | 25 | | |
| V _{LO} | Low side output voltage | -0.3 | V _{CC} + 0.3 | | |
| V _{IN} | Logic input voltage (HIN & LIN - IR2181/IR21814) | V _{SS} - 0.3 | V _{SS} + 10 | | |
| V _{SS} | Logic ground (IR21814 only) | V _{CC} - 25 | V _{CC} + 0.3 | | |
| dV _S /dt | Allowable offset supply voltage transient | — | 50 | V/ns | |
| P _D | Package power dissipation @ T _A ≤ +25°C | (8-lead PDIP) | — | 1.0 | W |
| | | (8-lead SOIC) | — | 0.625 | |
| | | (14-lead PDIP) | — | 1.6 | |
| | | (14-lead SOIC) | — | 1.0 | |
| R _{thJA} | Thermal resistance, junction to ambient | (8-lead PDIP) | — | 125 | °C/W |
| | | (8-lead SOIC) | — | 200 | |
| | | (14-lead PDIP) | — | 75 | |
| | | (14-lead SOIC) | — | 120 | |
| T _J | Junction temperature | — | 150 | °C | |
| T _S | Storage temperature | -50 | 150 | | |
| T _L | Lead temperature (soldering, 10 seconds) | — | 300 | | |

Recommended Operating Conditions

The Input/Output logic timing diagram is shown in figure 1. For proper operation the device should be used within the recommended conditions. The V_S and V_{SS} offset rating are tested with all supplies biased at 15V differential.

| Symbol | Definition | Min. | Max. | Units |
|-----------------|--|---------------------|---------------------|-------|
| V _B | High side floating supply absolute voltage | V _S + 10 | V _S + 20 | V |
| V _S | High side floating supply offset voltage | Note 1 | 600 | |
| V _{HO} | High side floating output voltage | V _S | V _B | |
| V _{CC} | Low side and logic fixed supply voltage | 10 | 20 | |
| V _{LO} | Low side output voltage | 0 | V _{CC} | |
| V _{IN} | Logic input voltage (HIN & LIN - IR2181/IR21814) | V _{SS} | V _{SS} + 5 | |
| V _{SS} | Logic ground (IR21814/IR21824 only) | -5 | 5 | |
| T _A | Ambient temperature | -40 | 125 | °C |

Note 1: Logic operational for V_S of -5 to +600V. Logic state held for V_S of -5V to -V_{BS}. (Please refer to the Design Tip DT97-3 for more details).

Note 2: HIN and LIN pins are internally clamped with a 5.2V zener diode.

Dynamic Electrical Characteristics

$V_{BIAS} (V_{CC}, V_{BS}) = 15V, V_{SS} = COM, C_L = 1000 \text{ pF}, T_A = 25^\circ C.$

| Symbol | Definition | Min. | Typ. | Max. | Units | Test Conditions |
|-----------|-------------------------------------|------|------|------|-------|-----------------------------|
| t_{on} | Turn-on propagation delay | — | 180 | 270 | nsec | $V_S = 0V$ |
| t_{off} | Turn-off propagation delay | — | 220 | 330 | | $V_S = 0V \text{ or } 600V$ |
| MT | Delay matching, HS & LS turn-on/off | — | 0 | 35 | | |
| t_r | Turn-on rise time | — | 40 | 60 | | $V_S = 0V$ |
| t_f | Turn-off fall time | — | 20 | 35 | | $V_S = 0V$ |

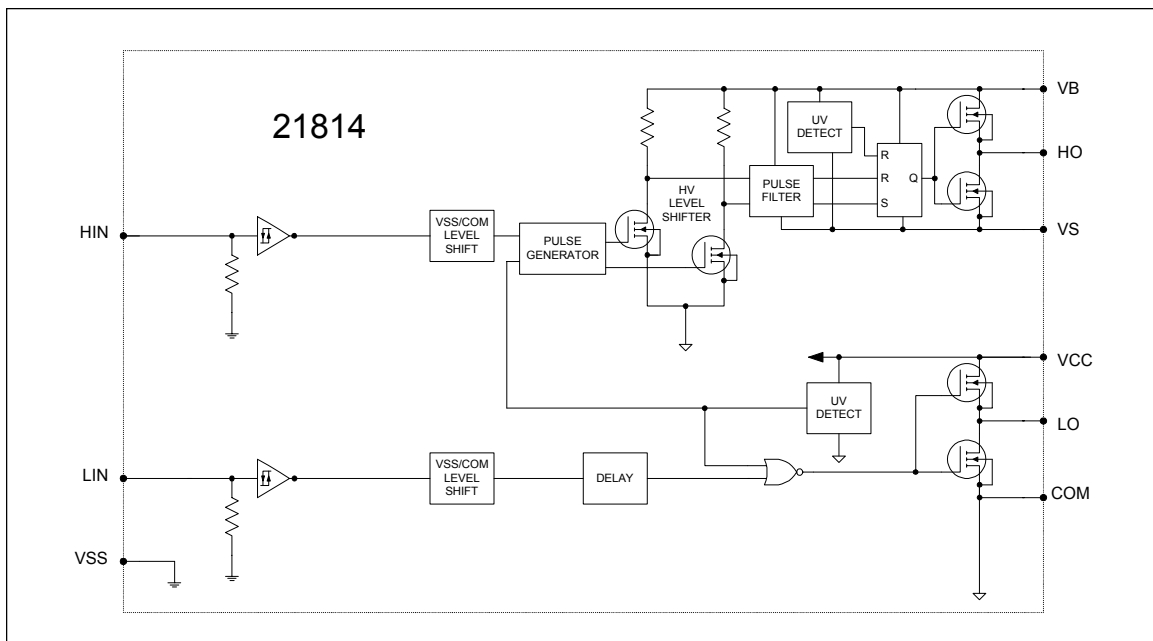
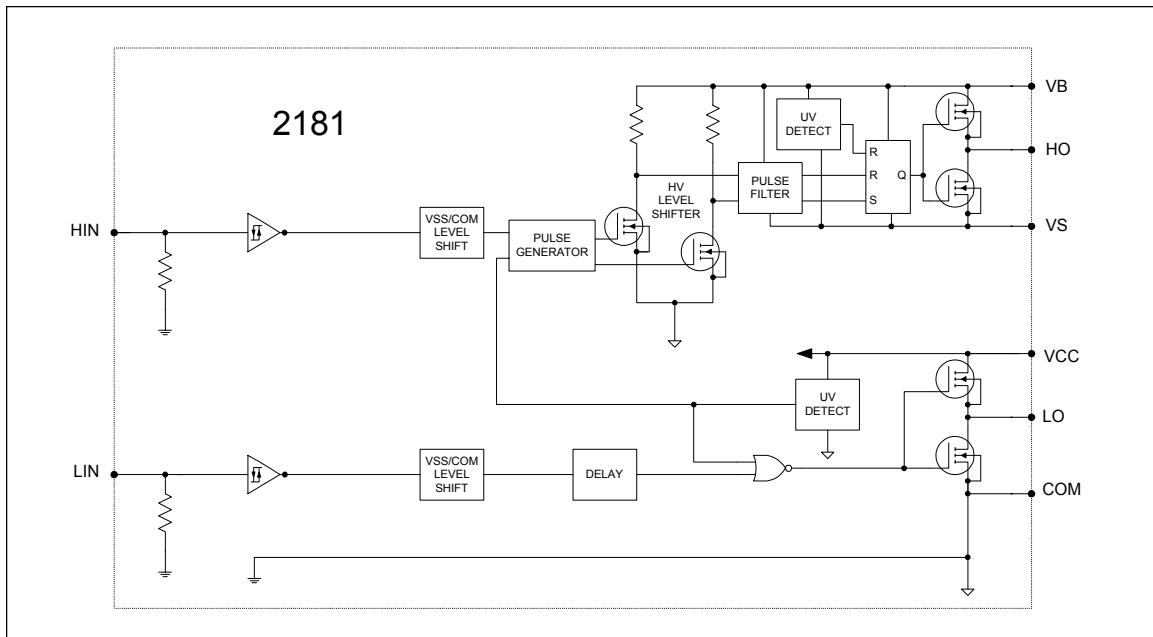
Static Electrical Characteristics

$V_{BIAS} (V_{CC}, V_{BS}) = 15V, V_{SS} = COM$ and $T_A = 25^\circ C$ unless otherwise specified. The V_{IL} , V_{IH} and I_{IN} parameters are referenced to V_{SS}/COM and are applicable to the respective input leads HIN and LIN. The V_O , I_O and R_{on} parameters are referenced to COM and are applicable to the respective output leads: HO and LO.

| Symbol | Definition | Min. | Typ. | Max. | Units | Test Conditions |
|----------------------------|--|------|------|------|---------|------------------------------------|
| V_{IH} | Logic "1" input voltage (IR2181/IR21814) | 2.7 | — | — | V | $V_{CC} = 10V \text{ to } 20V$ |
| V_{IL} | Logic "0" input voltage (IR2181/IR21814) | — | — | 0.8 | | $V_{CC} = 10V \text{ to } 20V$ |
| V_{OH} | High level output voltage, $V_{BIAS} - V_O$ | — | — | 1.2 | | $I_O = 0A$ |
| V_{OL} | Low level output voltage, V_O | — | — | 0.1 | | $I_O = 0A$ |
| I_{LK} | Offset supply leakage current | — | — | 50 | μA | $V_B = V_S = 600V$ |
| I_{QBS} | Quiescent V_{BS} supply current | 20 | 60 | 150 | | $V_{IN} = 0V \text{ or } 5V$ |
| I_{QCC} | Quiescent V_{CC} supply current | 50 | 120 | 240 | | $V_{IN} = 0V \text{ or } 5V$ |
| I_{IN+} | Logic "1" input bias current | — | 25 | 60 | | $V_{IN} = 5V$ |
| I_{IN-} | Logic "0" input bias current | — | — | 1.0 | | $V_{IN} = 0V$ |
| V_{CCUV+} V_{BSUV+} | V_{CC} and V_{BS} supply undervoltage positive going threshold | 8.0 | 8.9 | 9.8 | V | |
| V_{CCUV-} V_{BSUV-} | V_{CC} and V_{BS} supply undervoltage negative going threshold | 7.4 | 8.2 | 9.0 | | |
| V_{CCUVH} V_{BSUVH} | Hysteresis | 0.3 | 0.7 | — | | |
| I_{O+} | Output high short circuit pulsed current | 1.4 | 1.9 | — | A | $V_O = 0V,$ $PW \leq 10 \mu s$ |
| I_{O-} | Output low short circuit pulsed current | 1.8 | 2.3 | — | | $V_O = 15V,$ $PW \leq 10 \mu s$ |

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Functional Block Diagrams



Lead Definitions

| Symbol | Description |
|-----------------|--|
| HIN | Logic input for high side gate driver output (HO), in phase (IR2181/IR21814) |
| LIN | Logic input for low side gate driver output (LO), in phase (IR2181/IR21814) |
| VSS | Logic Ground (IR21814 only) |
| V _B | High side floating supply |
| HO | High side gate drive output |
| V _S | High side floating supply return |
| V _{CC} | Low side and logic fixed supply |
| LO | Low side gate drive output |
| COM | Low side return |

Lead Assignments

| | |
|--------------------|--------------------|
| <p>8-Lead PDIP</p> | <p>8-Lead SOIC</p> |
| IR2181 | IR2181S |

| | |
|---------------------|---------------------|
| <p>14-Lead PDIP</p> | <p>14-Lead SOIC</p> |
| IR21814 | IR21814S |



Figure 1. Input/Output Timing Diagram

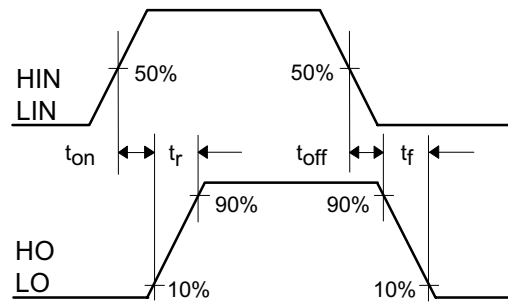


Figure 2. Switching Time Waveform Definitions



Figure 3. Delay Matching Waveform Definitions



Figure 4A. Turn-on Propagation Delay vs. Temperature



Figure 4B. Turn-on Propagation Delay vs. Supply Voltage



Figure 5A. Turn-off Propagation Delay vs. Temperature



Figure 5B. Turn-off Propagation Delay vs. Supply Voltage

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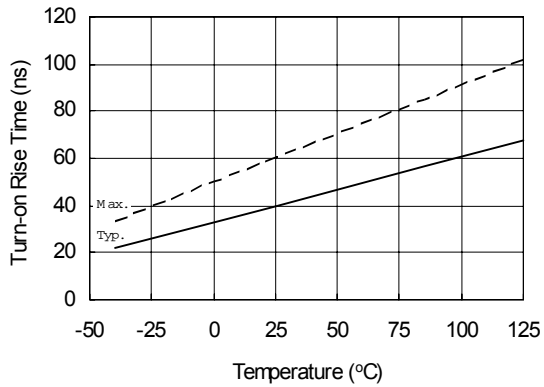


Figure 6A. Turn-on Rise Time vs. Temperature

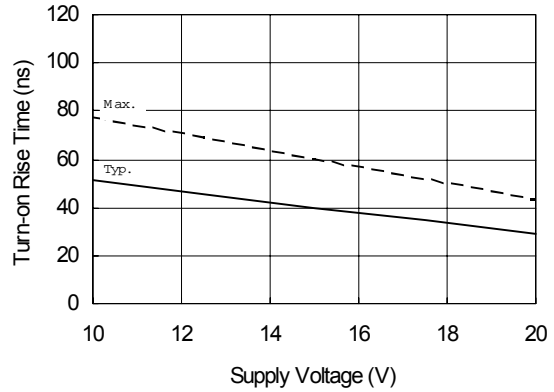


Figure 6B. Turn-on Rise Time vs. Supply Voltage

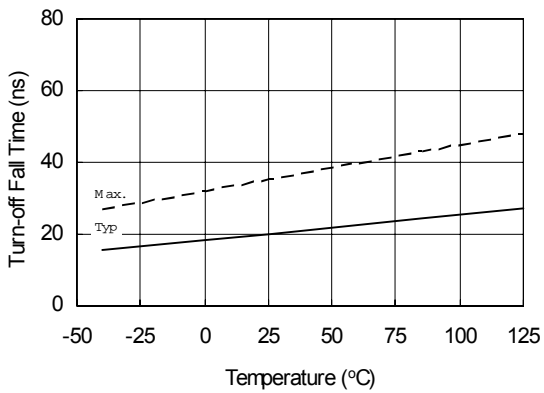


Figure 7A. Turn-off Fall Time vs. Temperature

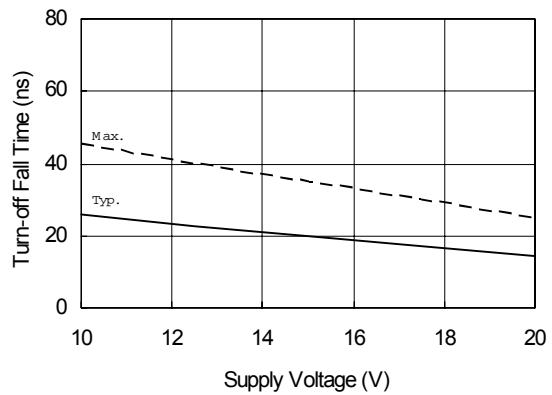


Figure 7B. Turn-off Fall Time vs. Supply Voltage

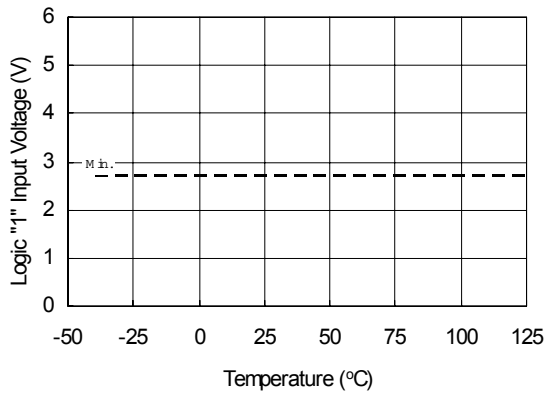


Figure 8A. Logic "1" Input Voltage vs. Temperature

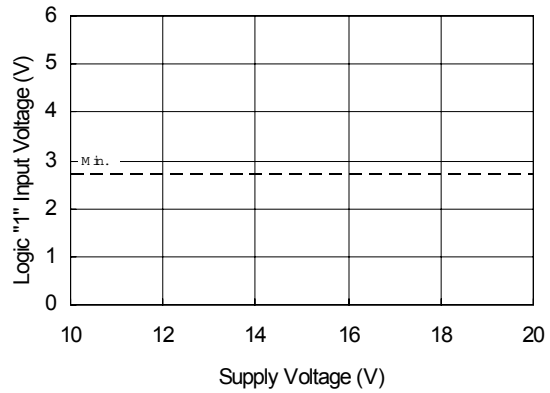


Figure 8B. Logic "1" Input Voltage vs. Supply Voltage

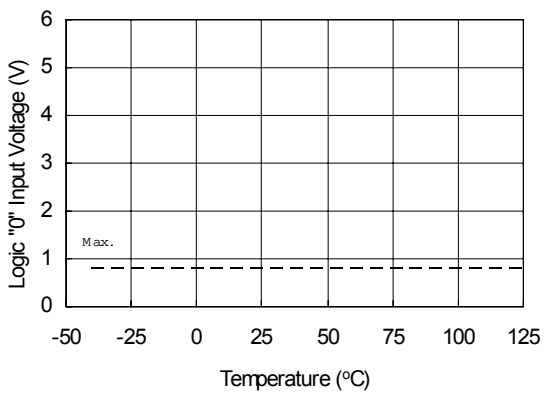


Figure 9A. Logic "0" Input Voltage vs. Temperature

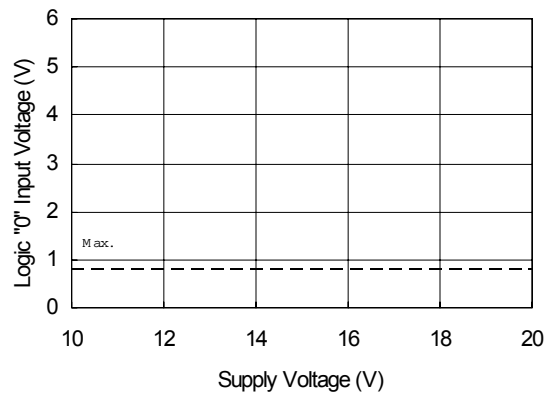


Figure 9B. Logic "0" Input Voltage vs. Supply Voltage

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Figure 10A. High Level Output vs. Temperature

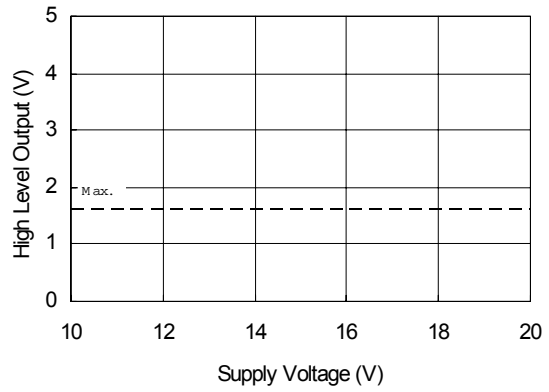


Figure 10B. High Level Output vs. Supply Voltage



Figure 11A. Low Level Output vs. Temperature

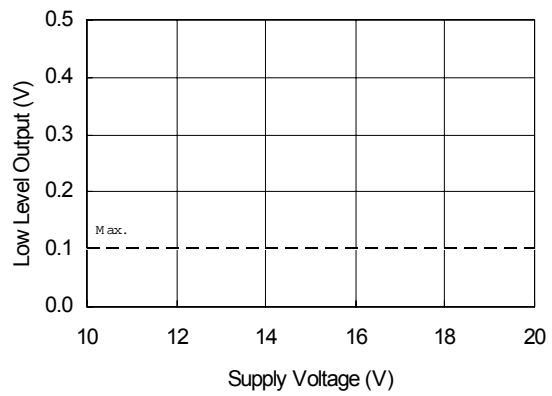


Figure 11B. Low Level Output vs. Supply Voltage

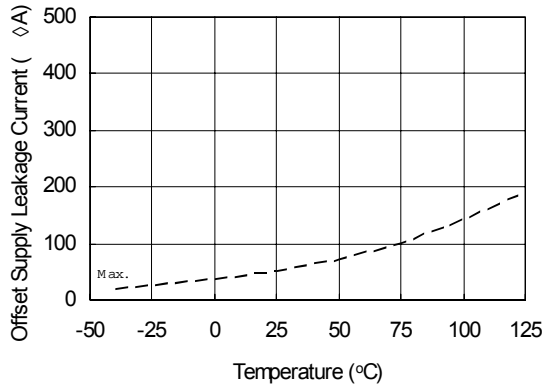


Figure 12A. Offset Supply Leakage Current vs. Temperature



Figure 12B. Offset Supply Leakage Current vs. V_B Boost Voltage

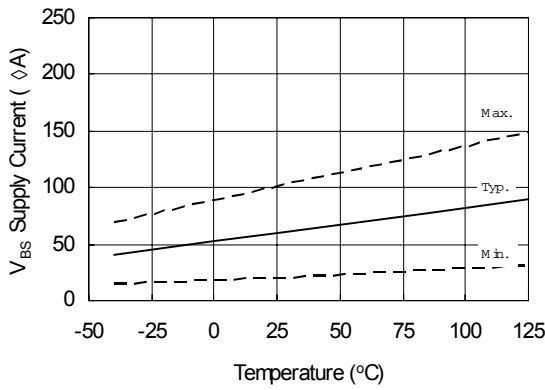


Figure 13A. V_{BS} Supply Current vs. Temperature

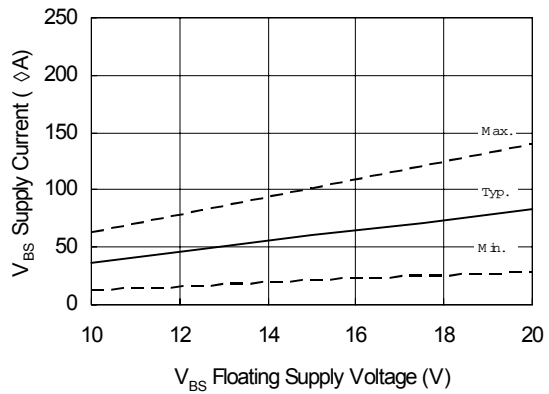


Figure 13B. V_{BS} Supply Current vs. V_{BS} Floating Supply Voltage

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Figure 14A. V_{CC} Supply Current vs. V_{CC} Temperature



Figure 14B. V_{CC} Supply Current vs. V_{CC} Supply Voltage

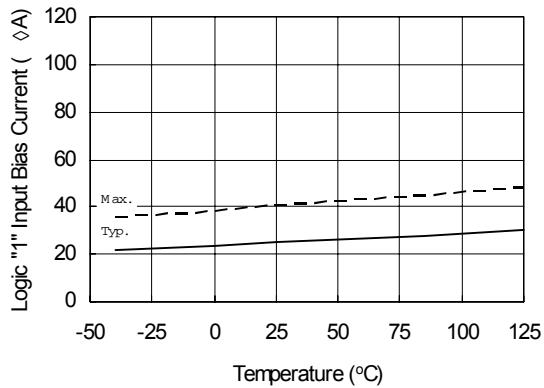


Figure 15A. Logic "1" Input Bias Current vs. Temperature



Figure 15B. Logic "1" Input Bias Current vs. Supply Voltage

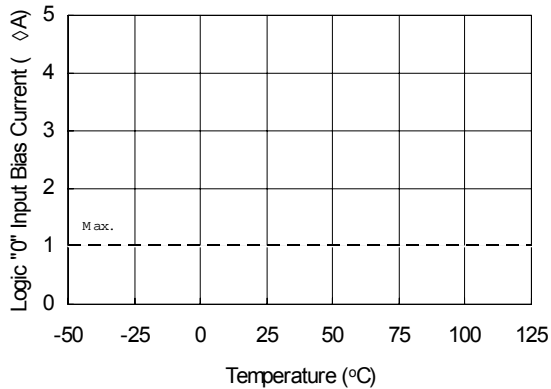


Figure 16A. Logic "0" Input Bias Current vs. Temperature

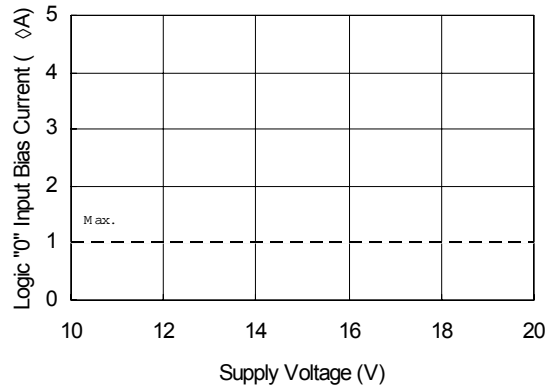


Figure 16B. Logic "0" Input Bias Current vs. Supply Voltage

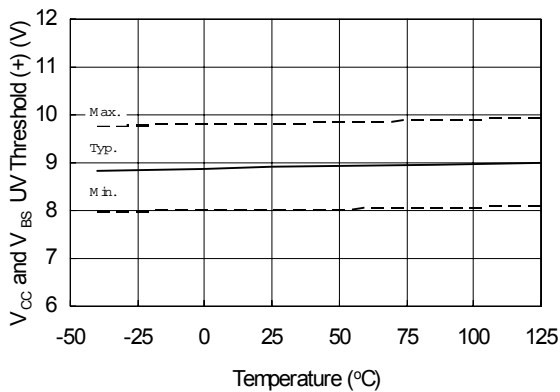


Figure 17. V_{CC} and V_{BS} Undervoltage Threshold (+) vs. Temperature

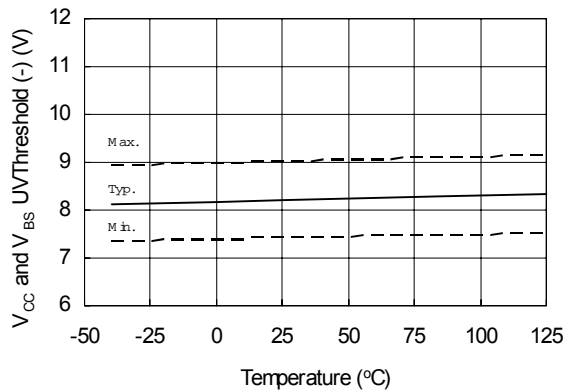


Figure 18. V_{CC} and V_{BS} Undervoltage Threshold (-) vs. Temperature

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Figure 19A. Output Source Current vs. Temperature



Figure 19B. Output Source Current vs. Supply Voltage

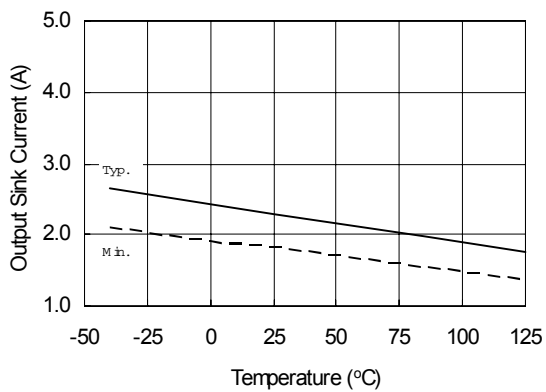


Figure 20A. Output Sink Current vs. Temperature

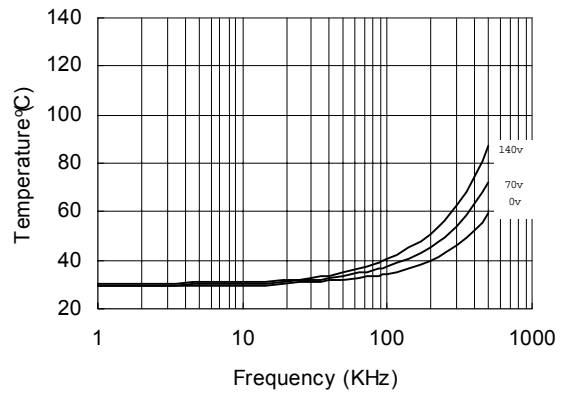


Figure 20B. Output Sink Current vs. Supply Voltage

IR2181(4) (S) & (PbF)



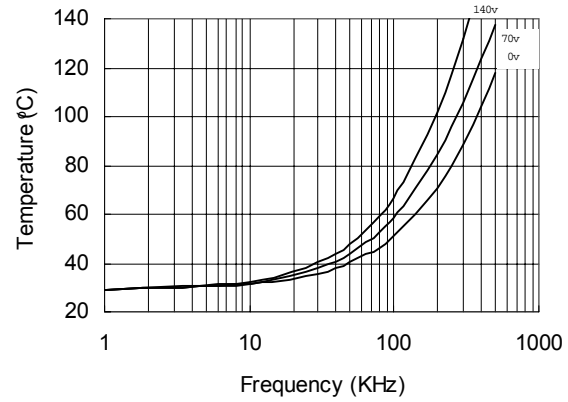
**Figure 21. IR2181 vs. Frequency (IRFBC20),
 $R_{gate}=33\Omega, V_{CC}=15V$**



**Figure 22. IR2181 vs. Frequency (IRFBC30),
 $R_{gate}=22\Omega, V_{CC}=15V$**



**Figure 23. IR2181 vs. Frequency (IRFBC40),
 $R_{gate}=15\Omega, V_{CC}=15V$**



**Figure 24. IR2181 vs. Frequency (IRFPE50),
 $R_{gate}=10\Omega, V_{CC}=15V$**

IR2181(4) (S) & (PbF)



Figure 25. IR21814 vs .Frequency (IRFBC 20),
 $R_{gate}=33\Omega, V_{CC}=15V$

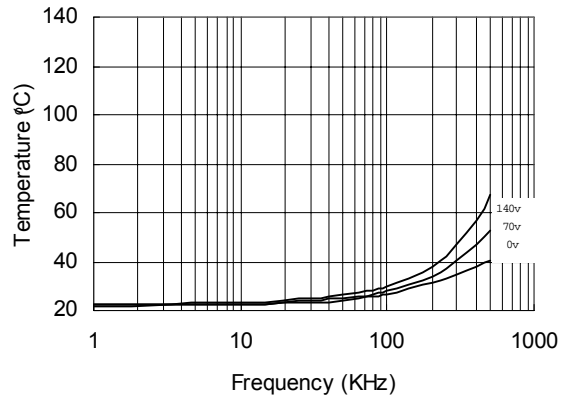


Figure 26. IR21814 vs .Frequency (IRFBC 30),
 $R_{gate}=22\Omega, V_{CC}=15V$

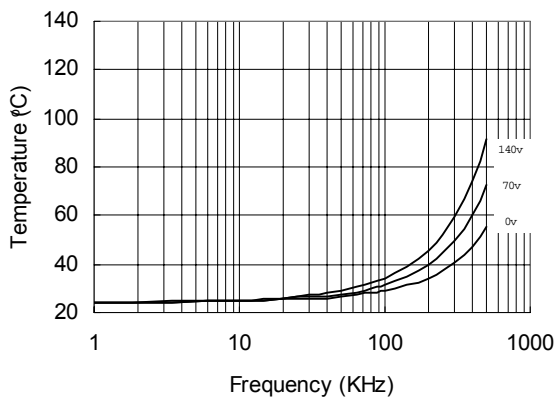


Figure 27. IR21814 vs .Frequency (IRFBC 40),
 $R_{gate}=15\Omega, V_{CC}=15V$



Figure 28. IR21814 vs .Frequency (IRFPE50),
 $R_{gate}=10\Omega, V_{CC}=15V$

IR2181(4) (S) & (PbF)



Figure 29. IR2181s vs. Frequency (IRFBC 20),
 $R_{gate} = 33\Omega, V_{CC} = 15V$

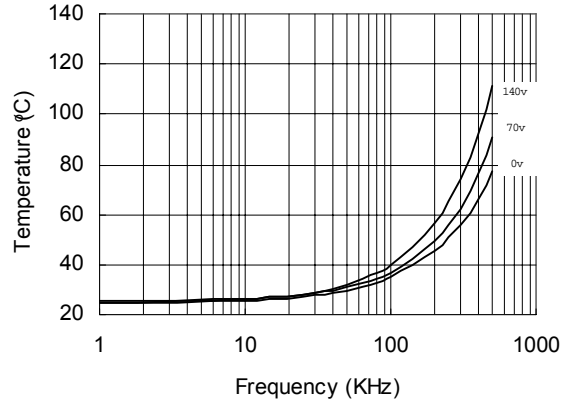


Figure 30. IR2181s vs. Frequency (IRFBC 30),
 $R_{gate} = 22\Omega, V_{CC} = 15V$



Figure 31. IR2181s vs. Frequency (IRFBC 40),
 $R_{gate} = 15\Omega, V_{CC} = 15V$



Figure 32. IR2181s vs. Frequency (IRFPE50),
 $R_{gate} = 10\Omega, V_{CC} = 15V$

IR2181(4) (S) & (PbF)



Figure 33. IR21814s vs. Frequency (RFBC 20),
 $R_{gate} = 33\Omega, V_{CC} = 15V$



Figure 34. IR21814s vs. Frequency (RFBC 30),
 $R_{gate} = 22\Omega, V_{CC} = 15V$



Figure 35. IR21814s vs. Frequency (RFBC 40),
 $R_{gate} = 15\Omega, V_{CC} = 15V$

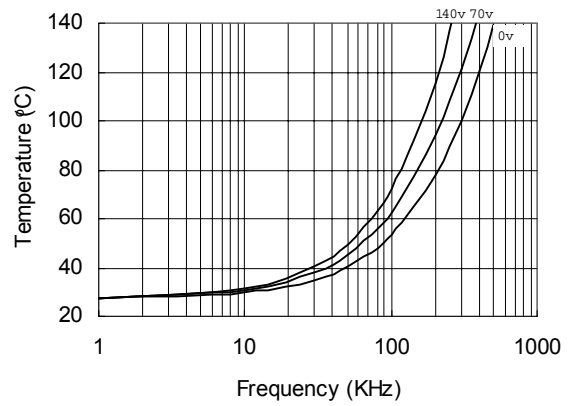


Figure 36. IR21814s vs. Frequency (RFPE50),
 $R_{gate} = 10\Omega, V_{CC} = 15V$

Case outlines



IR2181(4) (S) & (PbF)

International
IR Rectifier



LEADFREE PART MARKING INFORMATION



ORDER INFORMATION

Basic Part (Non-Lead Free)

8-Lead PDIP IR2181 order IR2181
 8-Lead SOIC IR2181S order IR2181S
 14-Lead PDIP IR21814 order IR21814
 14-Lead SOIC IR21814 order IR21814S

Leadfree Part

8-Lead PDIP IR2181 order IR2181PbF
 8-Lead SOIC IR2181S order IR2181SPbF
 14-Lead PDIP IR21814 order IR21814PbF
 14-Lead SOIC IR21814 order IR21814SPbF



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- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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